

PROTECTION PRODUCTS

Description

The LC03-6 transient voltage suppressor is designed to protect components which are connected to high speed telecommunication lines from voltage surges caused by **lightning**, electrostatic discharge (**ESD**), cable discharge events (**CDE**), and electrical fast transients (**EFT**).

TVS diodes are ideal for use as board level protection of sensitive semiconductor components. The LC03-6 combines a TVS diode with a rectifier bridge to provide transient protection in both common and differential mode with a single device. The capacitance of the device is minimized ($< 25\text{pF}$) to ensure correct signal transmission on high speed lines. The LC03-6 meets the short-haul (intra-building) transient immunity requirements of Bellcore 1089 for telecommunications applications.

The SO-8 surface mount package allows flexibility in the design of crowded PC boards.

Features

- ◆ 2000 watts peak pulse power ($t_p = 8/20\mu\text{s}$)
- ◆ Transient protection for high-speed data lines to **Bellcore 1089 (Intra-Building) 100A (2/10 μs)**
ITU K.20 $I_{pp}=40\text{A}$ (5/310 μs)
IEC 61000-4-2 (ESD) $\pm 15\text{kV}$ (air), $\pm 8\text{kV}$ (contact)
IEC 61000-4-4 (EFT) 40A (5/50ns)
IEC 61000-4-5 (Lightning) 100A (8/20 μs)
- ◆ Protects two lines in common and differential mode
- ◆ Low capacitance for high-speed interfaces
- ◆ Low clamping and operating voltage
- ◆ Integrated structure saves board space and increases reliability
- ◆ Solid-state silicon avalanche technology

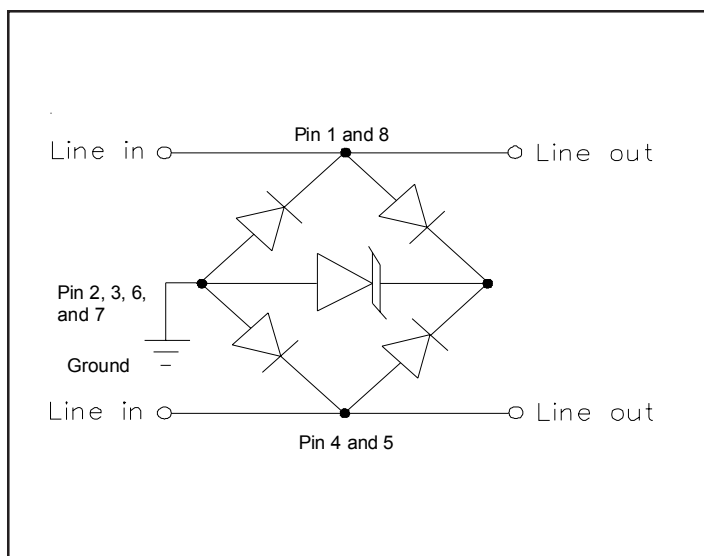
Mechanical Characteristics

- ◆ JEDEC SO-8 package
- ◆ UL 497B listed
- ◆ Molding compound flammability rating: UL 94V-0
- ◆ Marking : Part number, date code
- ◆ Packaging : Tube or Tape and Reel per EIA 481

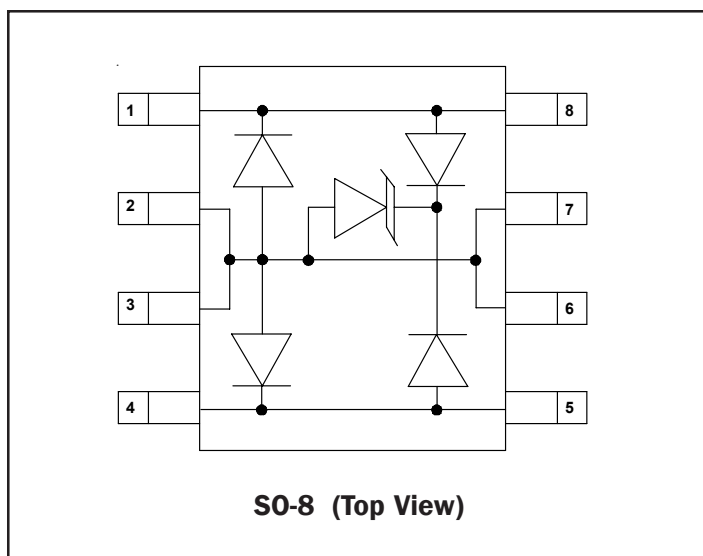
Applications

- ◆ T1/E1 Line Cards
- ◆ T3/E3 and DS3 Interfaces
- ◆ STS-1 Interfaces
- ◆ ISDN S/T-Interfaces
- ◆ ISDN U-Interfaces
- ◆ 10/100 Ethernet

Circuit Diagram



Schematic & PIN Configuration



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Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20\mu s$)	P_{pk}	2000	Watts
Peak Pulse Current ($t_p = 8/20\mu s$)	I_{pp}	100	A
Lead Soldering Temperature	T_L	260 (10 sec.)	°C
Operating Temperature	T_J	-55 to +125	°C
Storage Temperature	T_{STG}	-55 to +150	°C

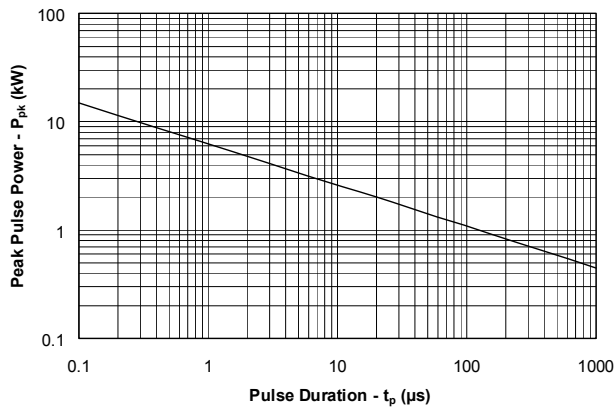
Electrical Characteristics

LC03-6						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				6	V
Reverse Breakdown Voltage	V_{BR}	$I_t = 1mA$	6.8			V
Reverse Leakage Current	I_R	$V_{RWM} = 6V, T=25^\circ C$			25	μA
Clamping Voltage	V_C	$I_{pp} = 50A, t_p = 8/20\mu s$ Line-to-Ground			15	V
Clamping Voltage	V_C	$I_{pp} = 100A, t_p = 8/20\mu s$ Line-to-Ground			20	V
Junction Capacitance	C_J	Between I/O pins and Ground $V_R = 0V, f = 1MHz$		16	25	pF
		Between I/O pins $V_R = 0V, f = 1MHz$		8	12	pF

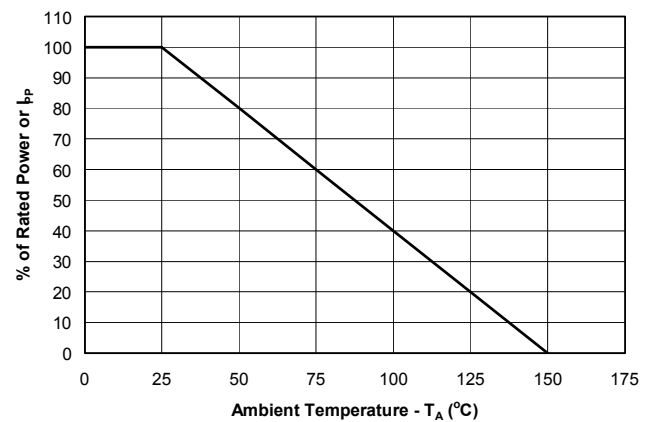
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Typical Characteristics

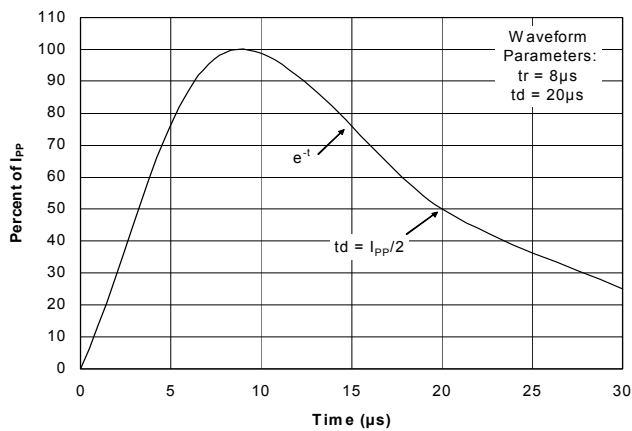
Non-Repetitive Peak Pulse Power vs. Pulse Time



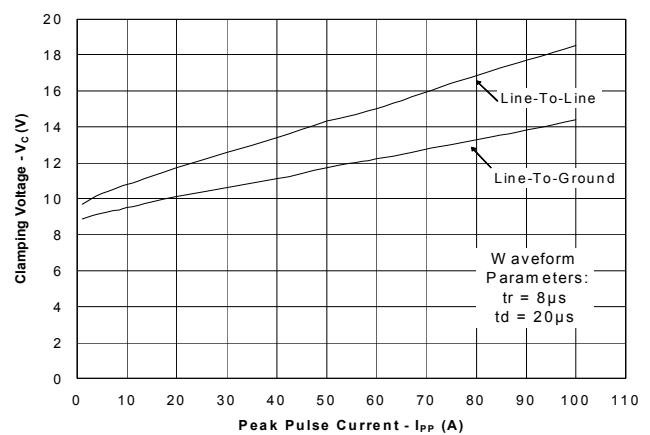
Power Derating Curve



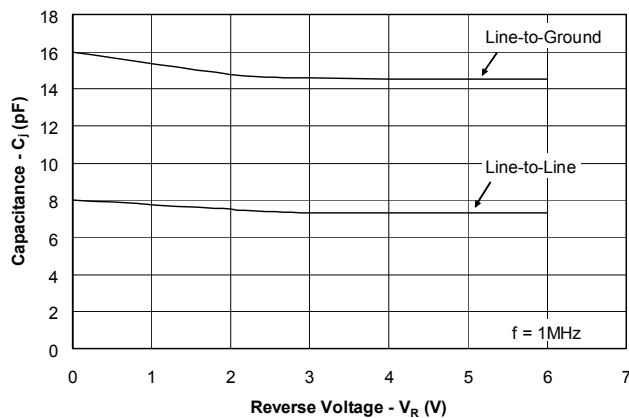
Pulse Waveform



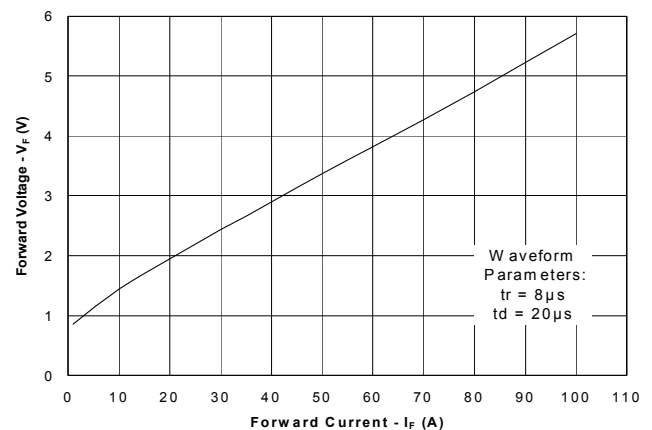
Clamping Voltage vs. Peak Pulse Current



Capacitance vs. Reverse Voltage



Forward Voltage vs. Forward Current



PROTECTION PRODUCTS**Typical Characteristics****Insertion Loss S21**

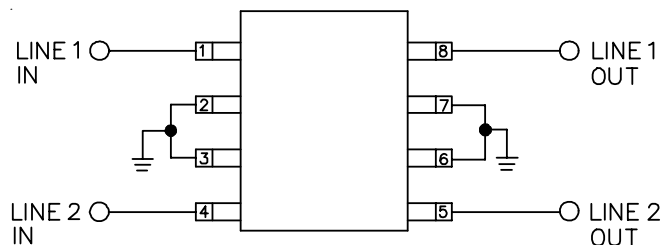
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Applications Information

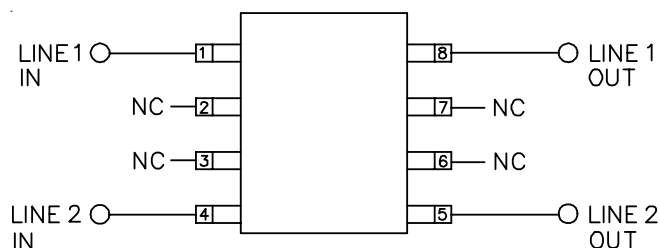
Device Connection Options for Protection of Two High-Speed Data Lines

The LC03-6 is designed to protect two high-speed data lines (one differential pair) from transient over-voltages which result from lightning and ESD. The device can be configured to protect in differential (Line-to-Line) and common (Line-to-Ground) mode. Data line inputs/outputs are connected at pins 1 to 8, and 4 to 5 as shown. Pins 2, 3, 6, and 7 are connected to ground. These pins should be connected directly to a ground plane on the board for best results. The path length is kept as short as possible to minimize parasitic inductance. In applications where high common mode voltages are present, differential protection is achieved by leaving pins 2, 3, 6, and 7 not connected.

Connection for Differential (Line-to-Line) and Common Mode Protection (Line-to-Ground)



Connection for Differential Protection (Line-to-Line)



T1/E1 Linecard Protection (Intra-Building)

A typical T1/E1 linecard protection circuit is shown below. The LC03-6 is connected between Tip and Ring on the transmit and receive line pairs. It provides protection to metallic and common mode lightning surges per Bellcore 1089. This design takes advantage of the isolation of the transformer to suppress common mode surges. To complete the protection circuit, the SRDA05-4 (or SRDA3.3-4 for 3.3V supplies) is employed as the IC side protection element. This device helps prevent the transceiver from latching up by providing fine clamping of transients that are coupled through the transformer. For further information, reference Semtech application note AN97-10.

T3/E3 and STS-1 Protection

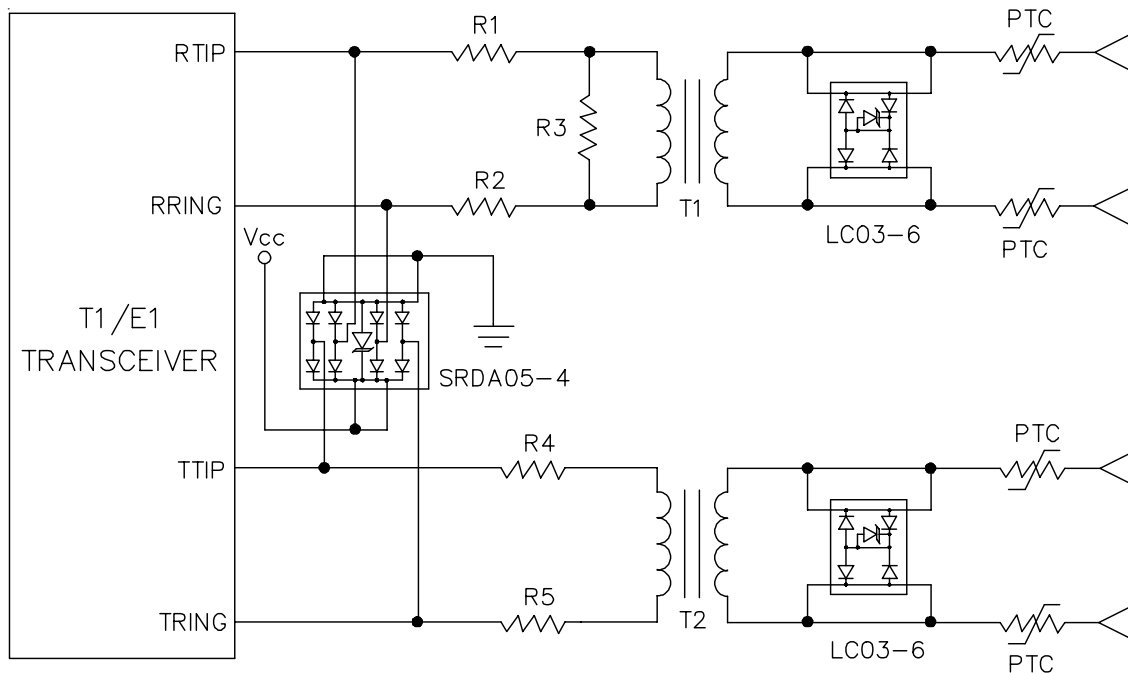
The LC03-6 can also be used to protect T3/E3 and STS-1 interfaces. The data lines from the BNC interface are run through the LC03-6 (i.e. enters at pin 1 and exits at pin 8) with the ground connection made at the other side of the device (pins 4 and 5). The center pins (2, 3, 6, and 7) are not connected. In this configuration, the LC03-6 adds less than 12pF of capacitance to each line and provides surge protection to 100A (tp=8/20μs).

Matte Tin Lead Finish

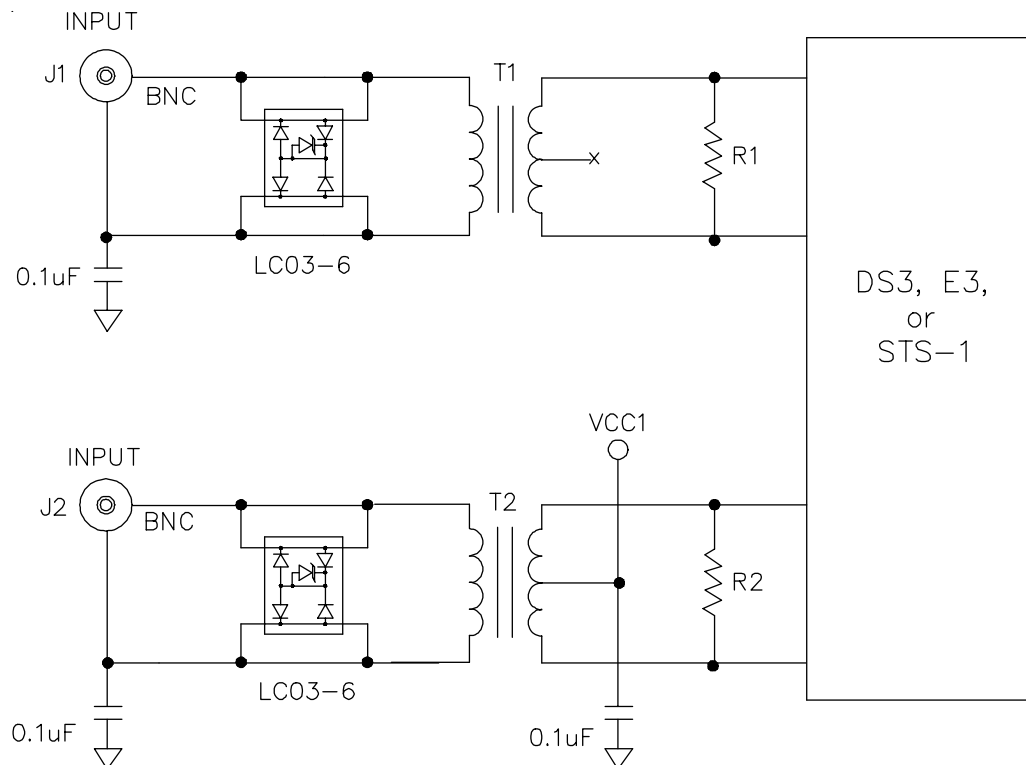
Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. In addition, unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation of the solder joint.

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Typical Applications



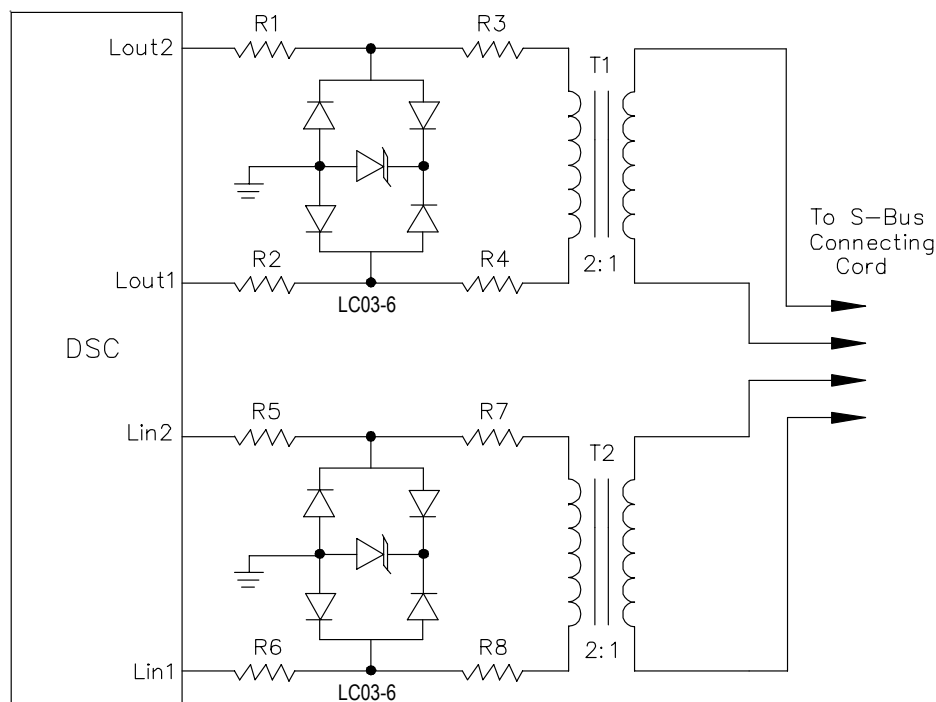
T1 Line Card Protection (Short-Haul Applications)



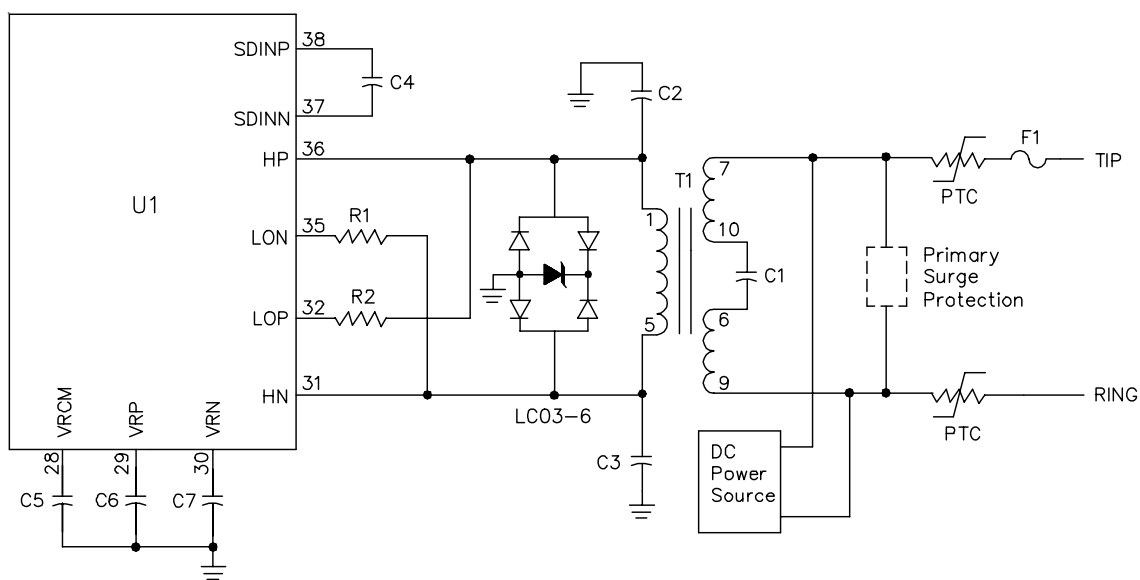
T3/E3 and STS-1 Protection

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Typical Applications (Continued)



ISDN S-Interface Protection



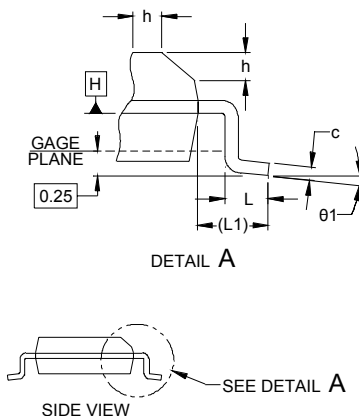
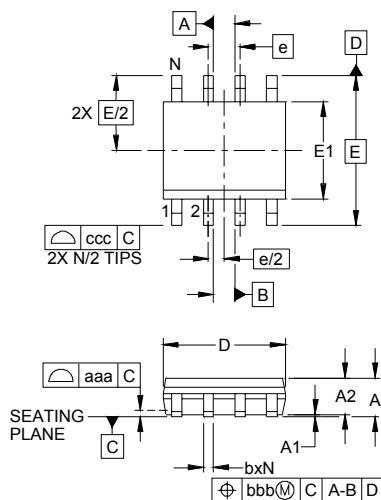
ISDN U-Interface Secondary Protection

Typical Applications (Continued)



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Outline Drawing - SO-8

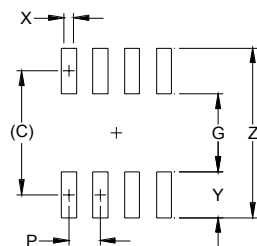


DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.053	-	.069	1.35	-	1.75
A1	.004	-	.010	0.10	-	0.25
A2	.049	-	.065	1.25	-	1.65
b	.012	-	.020	0.31	-	0.51
c	.007	-	.010	0.17	-	0.25
D	.189	.193	.197	4.80	4.90	5.00
E1	.150	.154	.157	3.80	3.90	4.00
E	.236 BSC			6.00 BSC		
e	.050 BSC			1.27 BSC		
h	.010	-	.020	0.25	-	0.50
L	.016	.028	.041	0.40	0.72	1.04
L1	(.041)			(1.04)		
N	8			8		
θ1	0°	-	8°	0°	-	8°
aaa	.004			0.10		
bbb	.010			0.25		
ccc	.008			0.20		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. DATUMS **-A-** AND **-B-** TO BE DETERMINED AT DATUM PLANE **-H-**
3. DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
4. REFERENCE JEDEC STD MS-012, VARIATION AA.

Land Pattern - SO-8



DIM	DIMENSIONS	
	INCHES	MILLIMETERS
C	(.205)	(5.20)
G	.118	3.00
P	.050	1.27
X	.024	0.60
Y	.087	2.20
Z	.291	7.40

NOTES:

1. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.
2. REFERENCE IPC-SM-782A, RLP NO. 300A.

PROTECTION PRODUCTS**Ordering Information**

Part Number	Lead Finish	Qty per Reel	Reel Size
LC03-6.TB	SnPb	500	7 Inch
LC03-6.TBT	Pb free	500	7 Inch

Contact Information

Semtech Corporation
Protection Products Division
200 Flynn Rd., Camarillo, CA 93012
Phone: (805)498-2111 FAX (805)498-3804